1. Part No. Expression:

<u>PIAQ1005S1R0MN</u>

(a) (b) (c) (d) (e)(f) a) Series Code b) Dimension Code c) Type Code

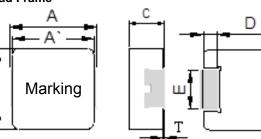
d) Inductance Code

- e) Tolerance Code
- f) Internal Control Code

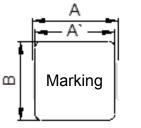
2. Configuration & Dimensions:

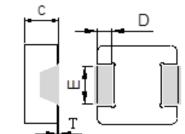
Lead Frame a.

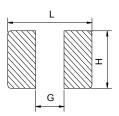
m



b. Non Lead Frame







Recommend PC Board Pattern

Note:

The above PCB layout is for reference only.
Solder paste thickness of 0.15mm and above is recommended.

Unit: mm

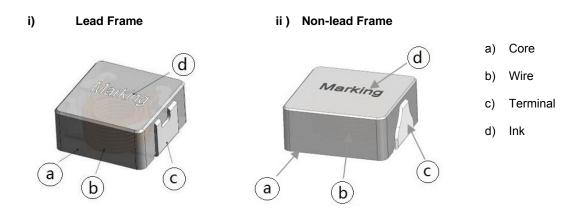
А	A`	В	С	D	Т	G	Н	L	E	Inductance	
44.0.0.5	10.0.0.5	10.0.0	10:00	0.0.0		E A	3.5	10.5	2.5±0.3	Between 0.68-1.50uH	
11.0±0.5	10.0±0.5	10.0±0.3	4.8±0.2	2.0±0.3	0 - 0.2	5.4		3.5	12.5	12.5	

3. Schematic:





4. Material List:



5. General Specification:

- (a) Reliability test for this part meets AEC-Q200 standard.
- (b) Operating Temp. : -55°C to +155°C (Inclusive of coil temp rise)
- (c) Storage Temp. : -55°C to +155°C (on board)
- (d) Humidity Range : 85 ± 3% RH
- (e) Heat Rated Current (Irms) will cause the coil temperature rise approximately ∆t of 40°C (keep 1min)
- (f) Saturation Current (Isat Typ.) will cause L0 to drop approximately 30%.
- (g) Part Temp. (Ambient + Temp. Rise) should not exceed 155°C under worst case operating conditions.
- (h) Storage condition (component in its packaging)
 - i) Temperature: -10 to 40°C
 - ii) Humidity : 50~60% RH

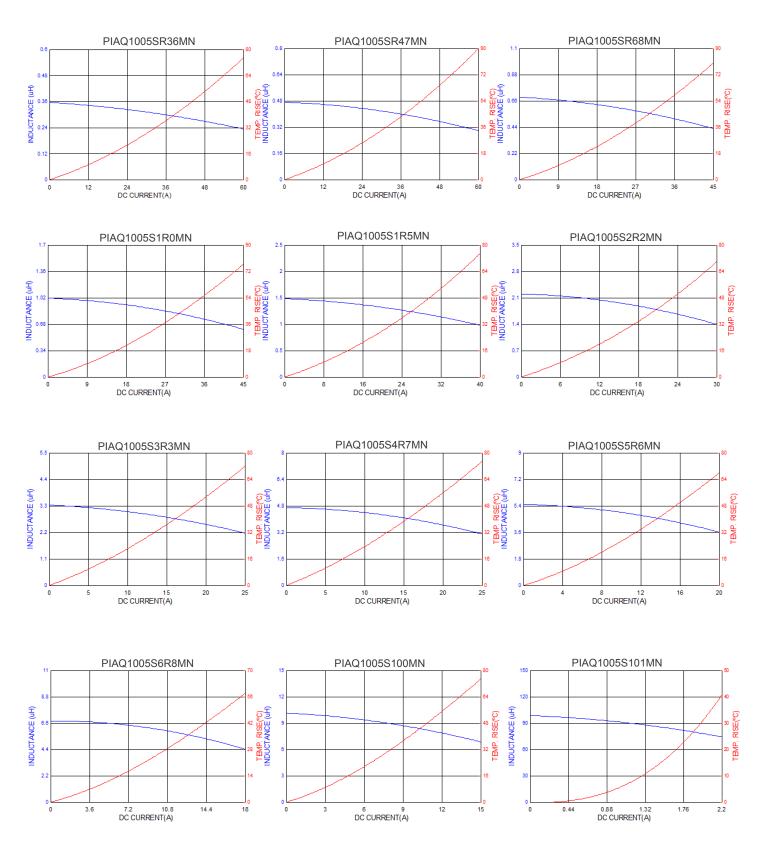
Part Number	Inductance Lo (uH) @ 0A	Test Frequency, L	Heat Rating Current DC (A) Irms.		Saturation Current DC (A) Isat.		DCR (mΩ)Typ.	DCR (mΩ)Max.	Туре	
	±20%		Тур.	Max.	Тур.	Max.				
PIAQ1005SR36MN	0.36	100kHz/1.0V	34.0	30.0	52.0	46.0	0.82	0.92	Non lead frame	
PIAQ1005SR47MN	0.47	100kHz/1.0V	33.0	29.0	46.0	40.0	1.15	1.32	Non lead frame	
PIAQ1005SR68MN	0.68	100kHz/1.0V	28.0	25.0	35.0	32.0	1.6	1.9	Non lead frame	
PIAQ1005S1R0MN	1.00	100kHz/1.0V	25.0	23.0	33.0	30.0	2.6	3.0	Non lead frame	
PIAQ1005S1R5MN	1.50	100kHz/1.0V	23.0	21.0	27.0	24.0	3.4	3.8	Non lead frame	
PIAQ1005S2R2MN	2.20	100kHz/1.0V	19.5	17.5	20.0	18.0	5.1	5.6	Lead frame	
PIAQ1005S3R3MN	3.30	100kHz/1.0V	17.0	15.0	17.5	15.5	8.1	9.1	Lead frame	
PIAQ1005S4R7MN	4.70	100kHz/1.0V	15.0	13.0	16.0	14.0	9.3	10.5	Lead frame	
PIAQ1005S5R6MN	5.60	100kHz/1.0V	13.0	11.0	15.0	12.5	12.8	14.4	Lead frame	
PIAQ1005S6R8MN	6.80	100kHz/1.0V	12.0	10.0	14.0	12.0	15.0	17.3	Lead frame	
PIAQ1005S100MN	10.0	100kHz/1.0V	7.6	7.2	13.0	11.0	18.9	21.8	Lead frame	
PIAQ1005S101MN	100.0	100kHz/1.0V	2.2	2.0	2.8	2.4	242.0	290.0	Lead frame	

6. Electrical Characteristics:

Notes:

1) At all times, the current supplied to the product should not exceed Isat Max. value.

7. Characteristics Curves:



NOTE: Specifications subject to change without notice. Please check our website for latest information.



10/11/2017

8. Soldering:

Mildly activated rosin fluxes are preferred. The minimum amount of solder can lead to damage from the stresses caused by the difference in coefficients of expansion between solder, chip and substrate. Our terminations are suitable for all re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air.

8-1 Solder Re-flow:

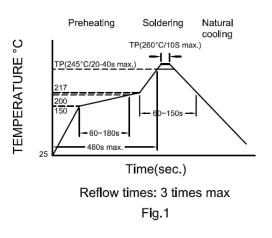
Recommended temperature profiles for re-flow soldering in Figure 1.

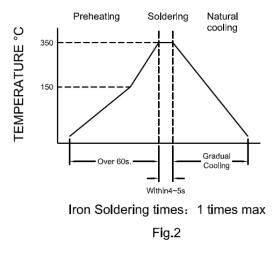
8-2 Soldering Iron (Figure 2):

Products attachment with soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended.

Note :

- a) Preheat circuit and products to 150°C.
- b) 355°C tip temperature (Max.)
- c) Never contact the ceramic with the iron tip
- d) 1.0mm tip diameter (Max.)
- e) Use a 20 watt soldering iron with tip diameter of 1.0mm
- f) Limit soldering time to 4~5 secs.



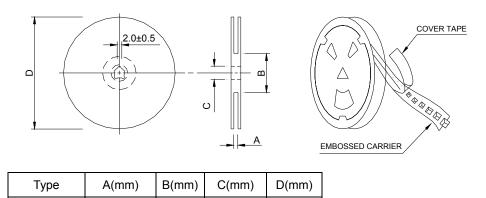


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SUPERWORLD ELECTRONICS (S) PTE LTD 西普爾電子(新)私营有限公司

9. Packaging Information:

9-1 Reel Dimension:



13.5±0.5

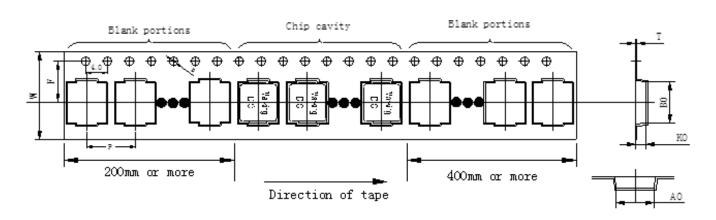
330

9-2 Tape Dimension:

24.4+2/-0

100±2

13"x24mm

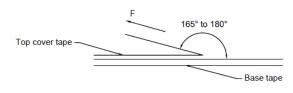


Series	Size	Bo(mm)	Ao(mm)	Ko(mm)	P(mm)	W(mm)	F(mm)	T(mm)	D(mm)
PIAQ	1005	11.6±0.1	10.4±0.1	5.3±0.1	16.0±0.1	24.0±0.3	11.5±0.1	0.35±0.05	1.5±0.1

9-3 Packaging Quantity:

PIAQ	1005
Chip / Reel	500
Inner box	1000
Carton	4000

9-4 Tearing Off Force:



The force for tearing off cover tape is 10 to 130 grams in the arrow direction under the following conditions.

Room Temp. (℃)	Room Humidity (%)	Room atm (hPa)	Tearing Speed mm/min	
5~35	45~85	860~1060	300	

Application Notice:

1. Storage Conditions:

To maintain the solderabililty of terminal electrodes:

- a) Recommended products should be used within 12 months from the time of delivery.
- b) The packaging material should be kept where no chlorine or sulfur exists in the air.

2. Transportation:

- a) Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- b) Vacuum pick up is strongly recommended for individual components.
- c) Bulk handling should ensure that abrasion and mechanical shock are minimized.